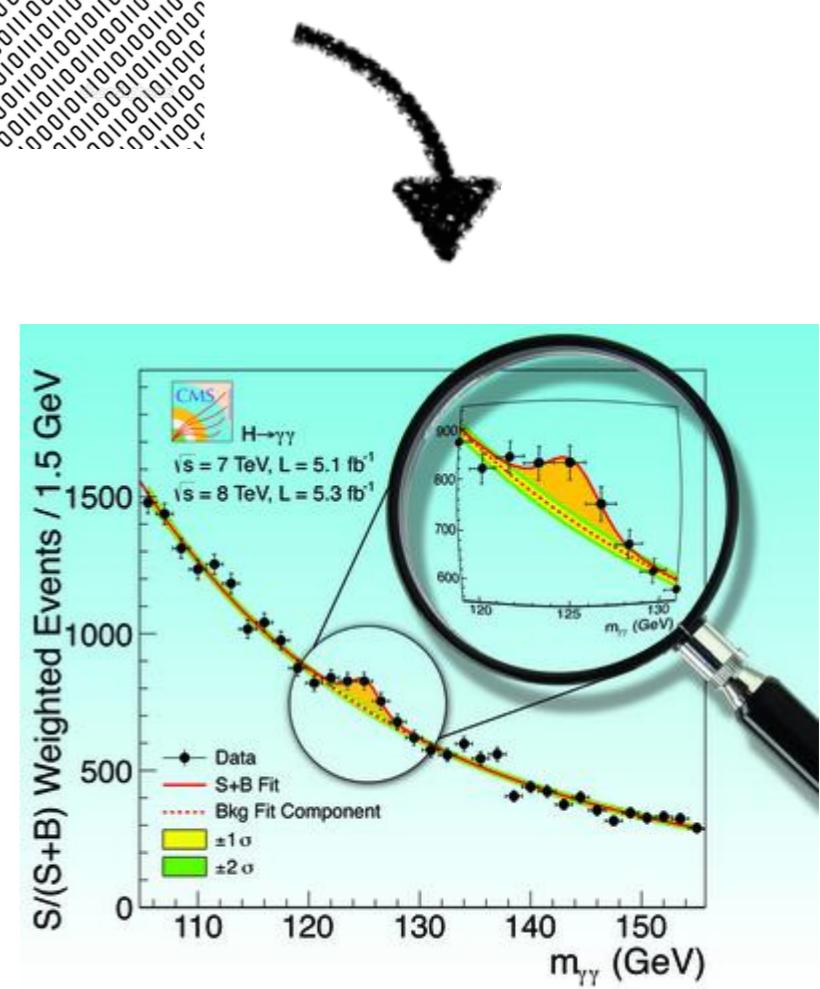
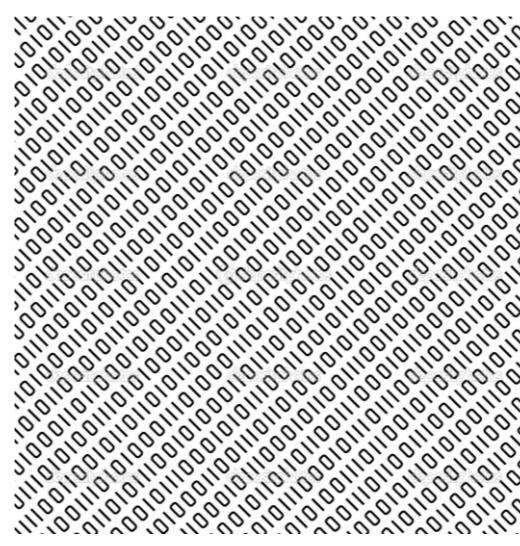
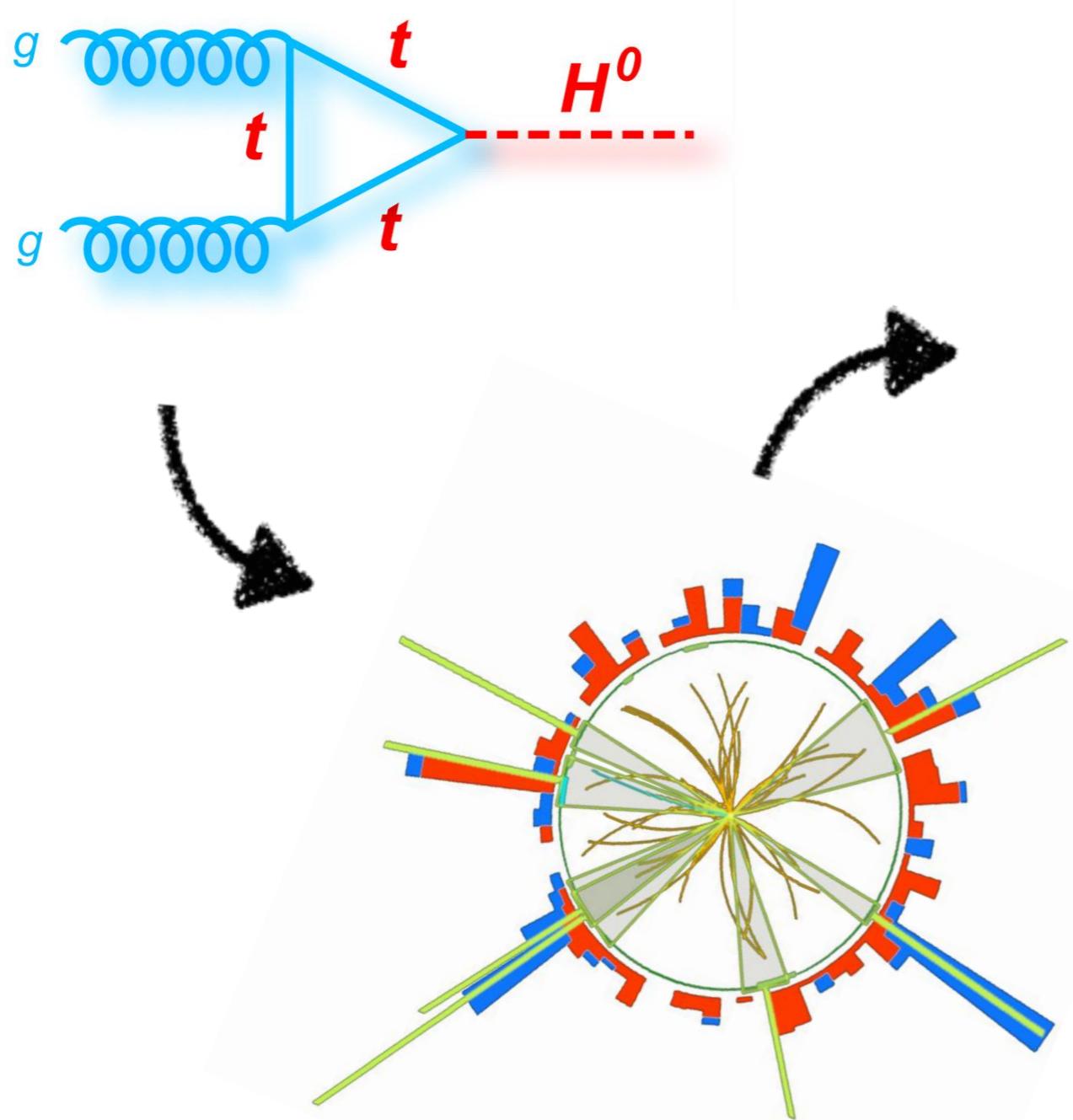
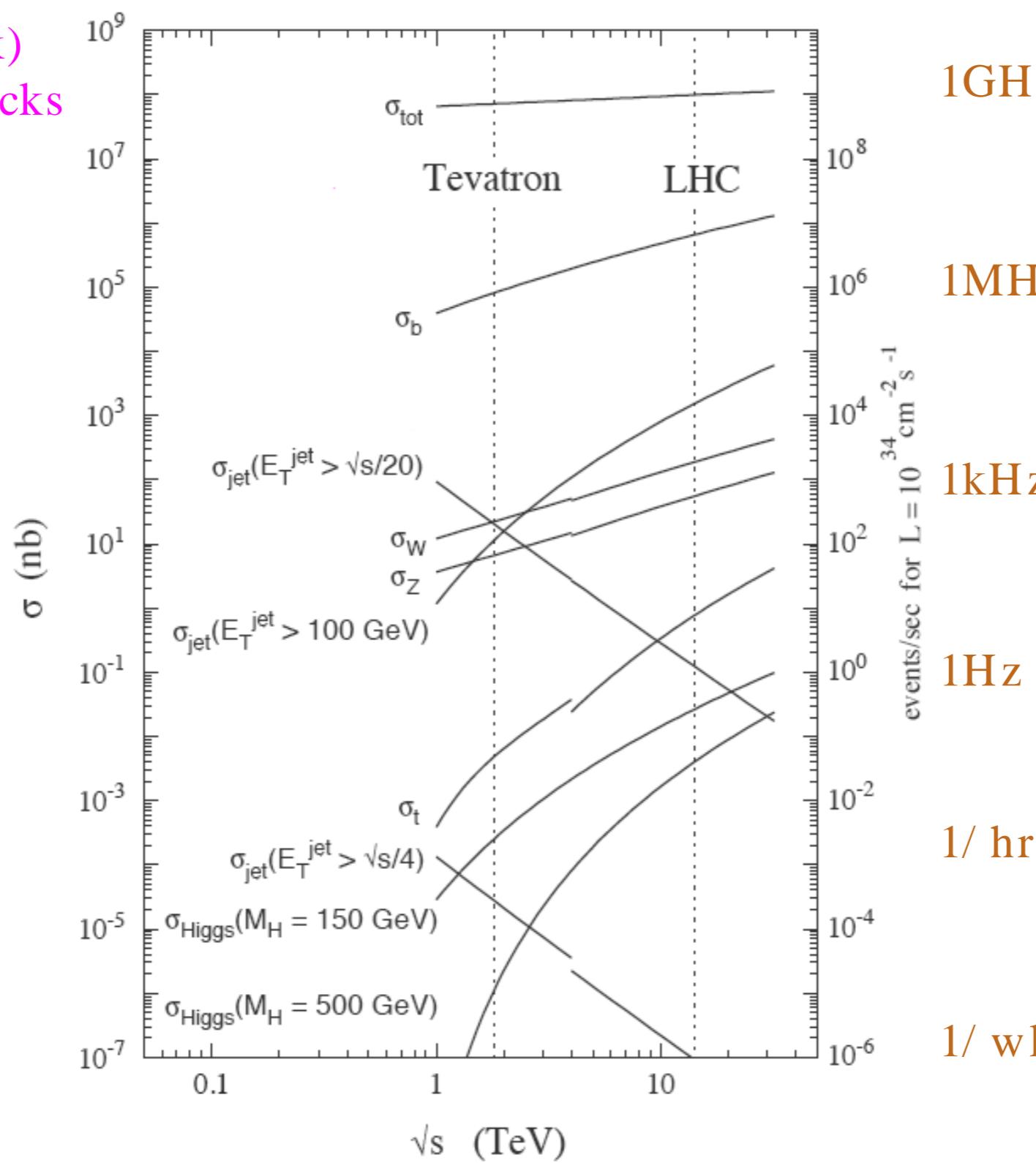
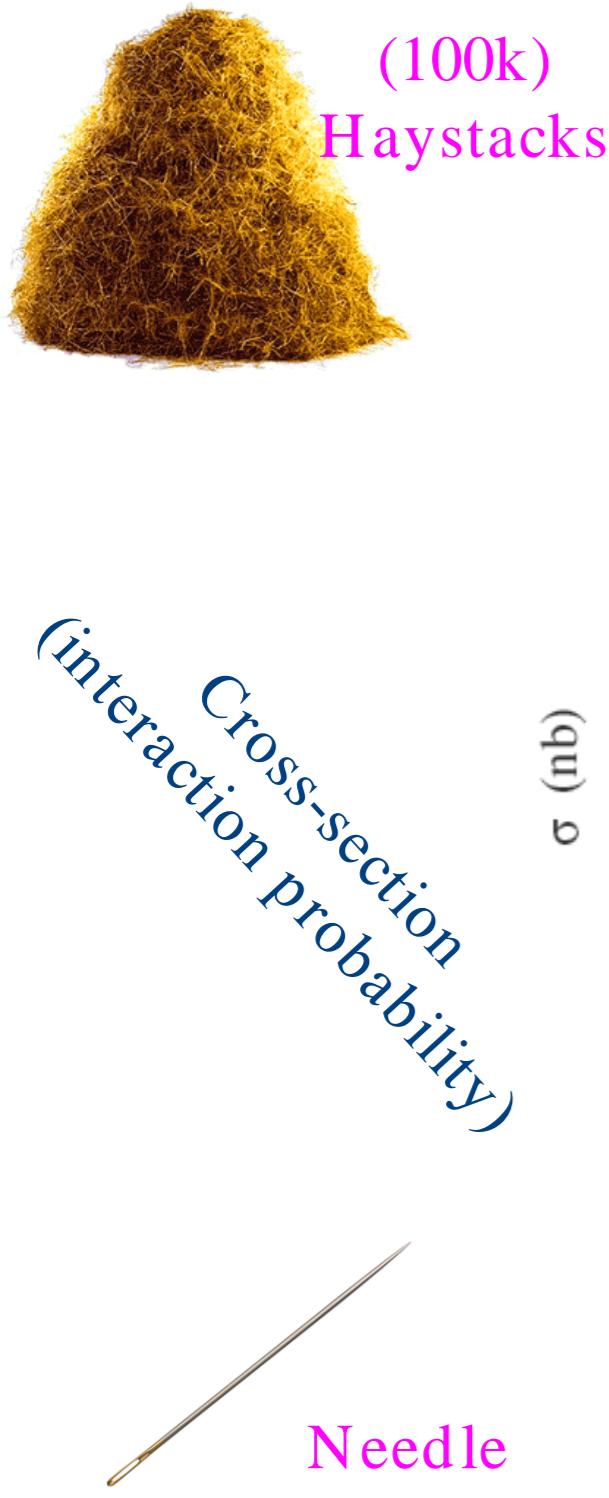


systems (ATLAS)



David Cussans, Bristol

Science Motivation



2008

2009

2010

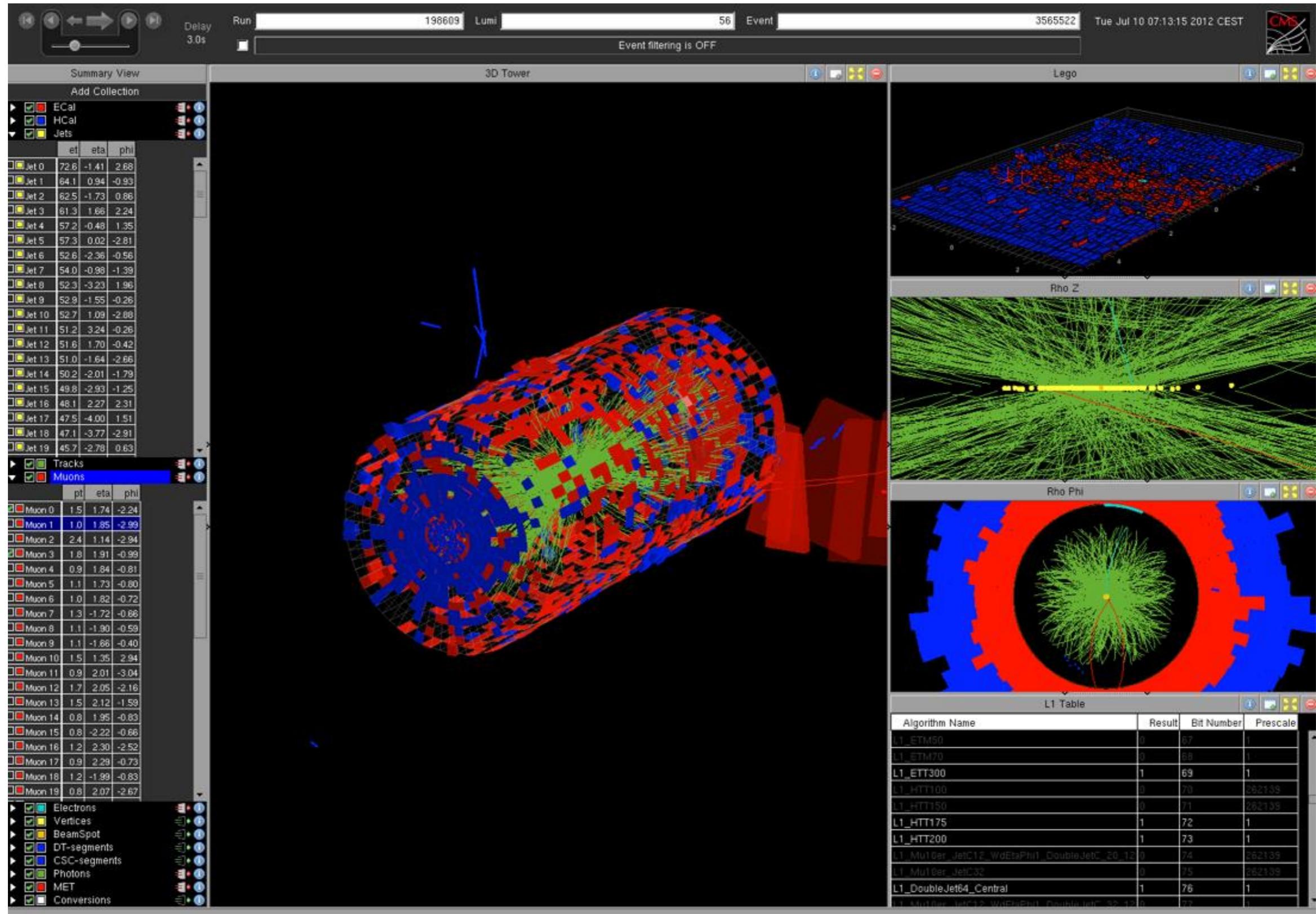
2011-2



QuickTime™ and a
decompressor
are needed to see this picture.



'Typical' 2012 Bunch Crossing





Detector Design

‣ LHC detector mission

- Find and measure incredibly rare events... (1/ hr)
- Against almost indistinguishable background of common events (1kHz)
- In an environment of incredibly high-rate background (1GHz)

‣ Detector characteristics

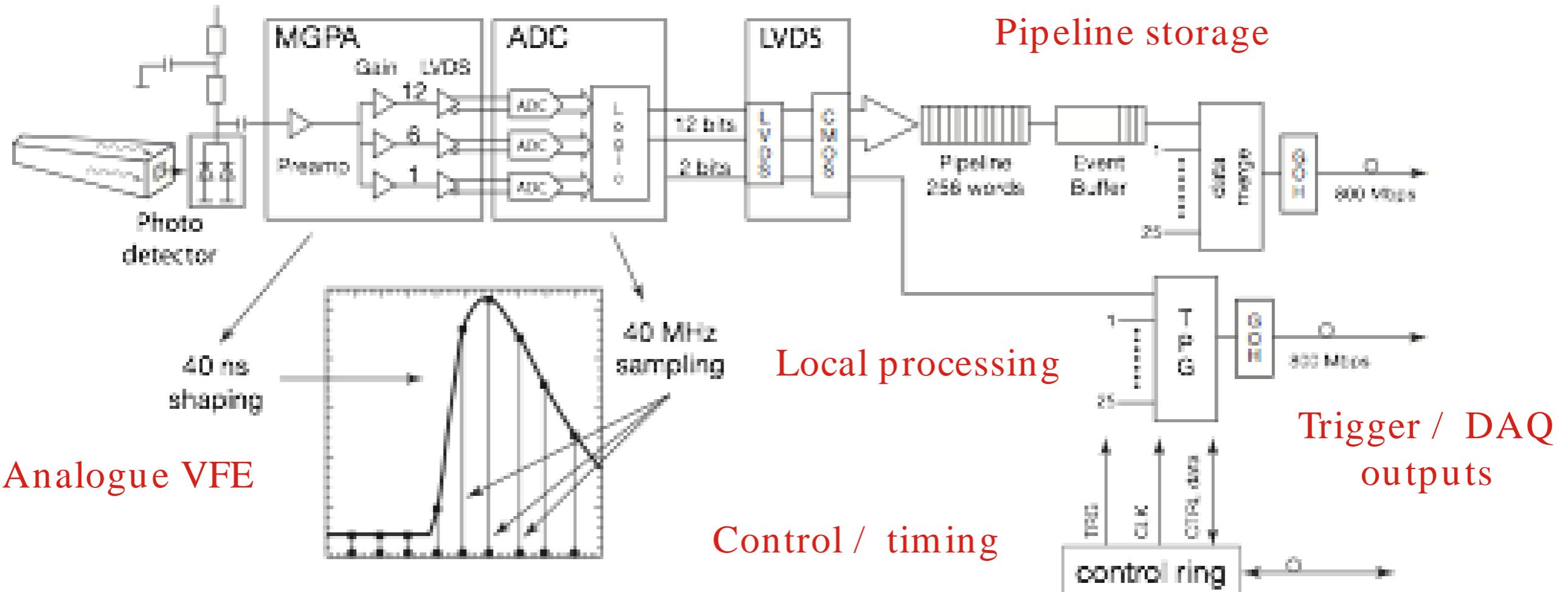
- Fast response time
 - Unique crossing-ID required -> 25ns time resolution
- Large area and hermeticity; lowest possible material for inner detectors
- High granularity
 - Efficient pattern recognition -> For low occupancy -> 10k's to M's of channels
- Good resolution, low noise, high dynamic range
 - Energy resolution in calorimetry; (interpolated) position information in tracking

‣ Environment for on-detector electronics

- Highly constrained in terms of space, cooling, access, services
- Electromagnetically noisy & high radiation dose in places

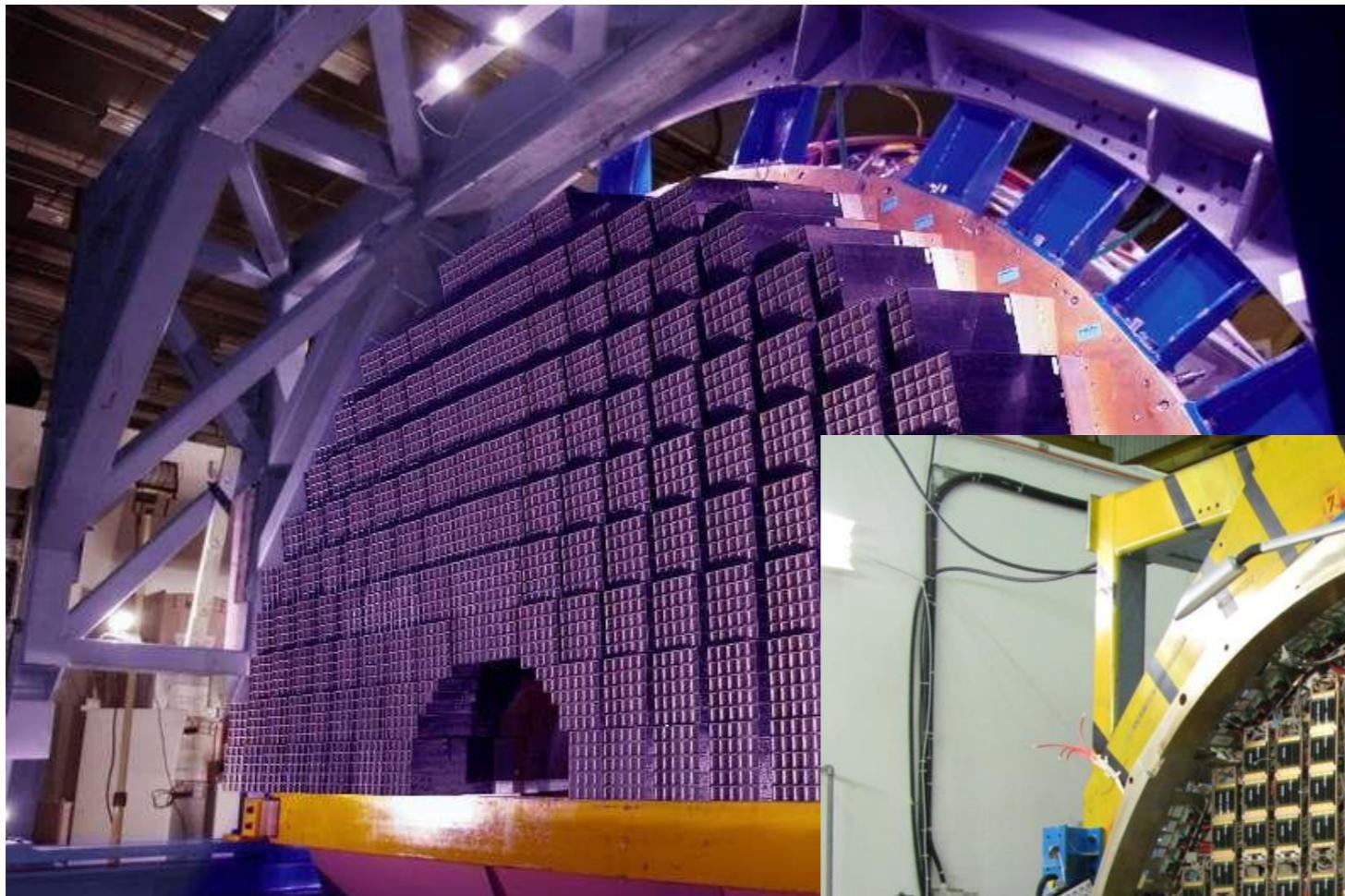
Front-End Electronics

Digital sampling

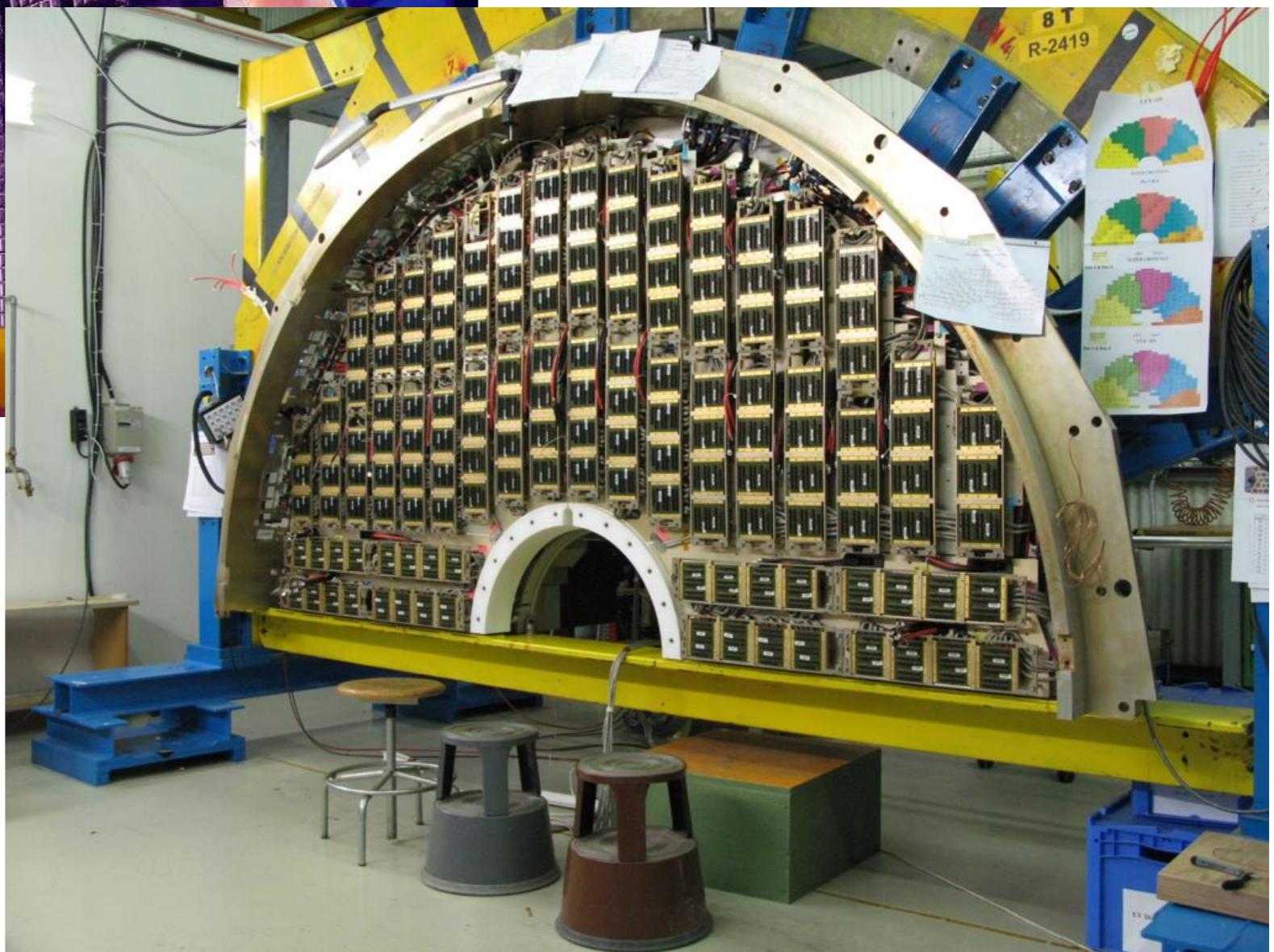


- e.g. CMS ECAL front end electronics (UK development)
 - ~80000 channels, 40Ms/ s, 12b resolution, 16 b dynamic range
- Based on two custom rad-hard CMS ASICs, 0.25 μ technology
 - Along with carefully qualified commercial optoelectronics, sensors

On Detector Electronics



- Design dictated by need to fit in detector and cope with environment.





Off Detector Electronics

- Receive data from detector, filter/ process, send for storage
- Different constraints from on-detector
 - Can use standard format electronics
 - Sub-racks housed in larger racks (sub-racks frequently 19-inches).
 - Racks provide power, cooling
- Standards change: NIM (1966), CAMAC (1976), FASTBUS (1986), VMEp (1998), xTCA(20xx)
- xTCA for HEP proposed at least ten years ago
 - (e.g. [An Initial Look at a CMS Level-1 Trigger for an Upgraded LHC, D.Cussans et. al., 10th Workshop on Electronics for LHC and Future Experiments, Boston, MA, USA, 13 - 17 Sep 2004, pp.73-76 DOI 10.5170/ CERN-2004-010.73](#))
- ... but only in last few years has “critical mass” developed.



Why Change?

- › Current generation of experiments mainly use VME. Why change?
- › Chasing more massive particles and smaller cross-sections --> need larger machines producing (much) more data.
- › Last decade revolution in analog, digital, communication technologies opened up new opportunities.
- › Parallel multi-drop bus --> point-to-point gigabit serial links.
 - › Follow lead from other areas: PCI-->PCIe , Parallel printer --> USB, PATA--> SATA
- › Programmable FPGA's allow much more functionality than discrete logic components. Micro-controllers now cheap
- › Multilayer board design enables Gigabit backplanes >10 GHz bandwidth
 - Integrated SERDES communications obsolete parallel bus backplanes

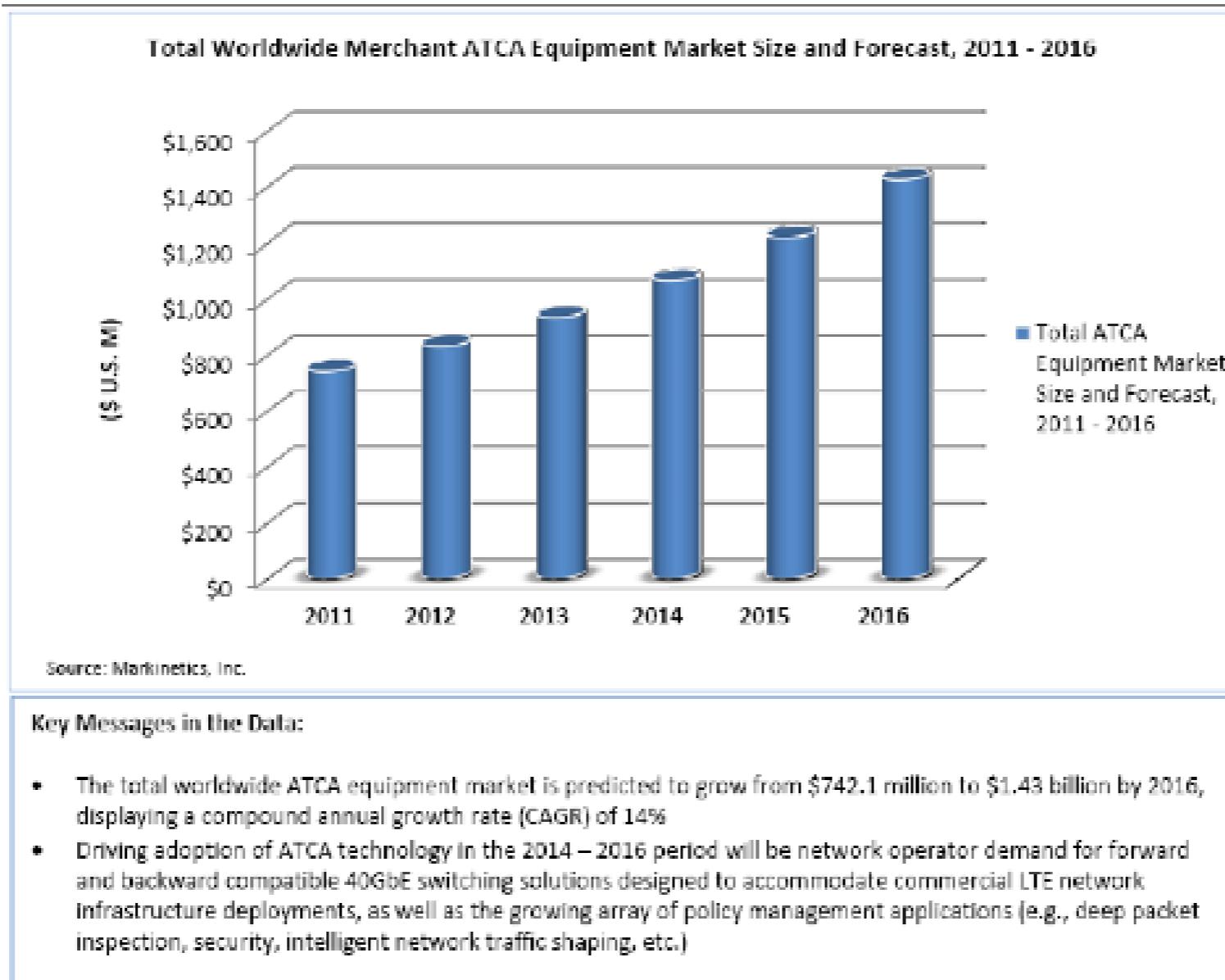


Acknowledgements

- Slides/ material taken from
 - **Introduction to MicroTCA** Ray Larsen SLAC MicroTCA Review June 4-5, 2012
 - **xTCA interest group** <https://twiki.cern.ch/twiki/bin/view/XTCA/WebHome>
 - Mark Pessaresi (FC7) , Andy Rose, Greg Isles (MP7)
 - Dave Newbold (IPBus)

Will xTCA disappear?

- ATCA (and especially uTCA) new standard, but don't look as if they are “here today, gone tomorrow”



Note:
Stated target of PICMG for ATCA was eventual penetration of global market of 10% of \$100B

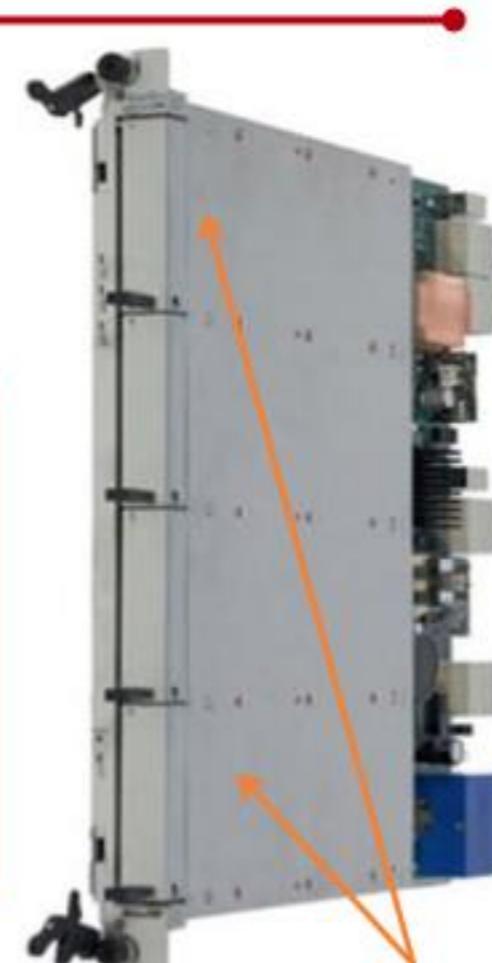
Note - Current ATCA market is approx same as total VME market

SLAC MicroTCA Standards Review

ATCA Shelf Carrier



ATCA Dual Star 14-Slot Shelf



ATCA Carrier w/ 4 AMCs



uTCA Components

> Introduction\ ESE-BE xTCA equipment

MTCA Crates

Vadatech VT892 MTCA.0
(12 AMCs, 2 MCHs, 2PMs, 2CUs)



ELMA 043-012 MTCA.4
(12 AMCs, 12 RTMs, 2 MCHs, 4PMs, 2CUs)



Schroff MTCA.4 + AC/DC CM100
(6 AMCs, 6 RTMs, 1 MCHs)



PMs

4xNAT DC780
(792W)



Vadatech UTC010
(792W)



Wiener AC/DC
(Prototype, 800W)



Vadatech



NAT MCH



MCHs

Kontron
AM4904



AMCs

ELMA Load Board



Kontron AM15030



ESD ADIO24



CCT AM31





A Brief Glossary....

Term	Definition
PICMG	PCI Industrial Computer Manufacturers Group, 250 corporations
ATCA	Advanced Telecommunications Computing Architecture large board
Carrier	ATCA or μ TCA board that supports smaller standard board
Shelf	Crate, ATCA (large) or μ TCA (small)
RTM/ μ RTM	Rear/Micro Rear Transition Module
AMC	Advanced Mezzanine Card mounting on ATCA Carrier, μ TCA shelf
Micro/ μ TCA	Crate designed to support AMCs directly
MCH	MicroTCA Carrier Hub switch module for μ TCA shelf
PU, CU	Power Unit (Module), Cooling Unit (fan or fan tray)
IPMI	Intelligent Platform Management Interface
Shelf Mgr	Shelf board hosting IPMI controller (BMC, MMC controllers)
Wide, High	High (vertical module height), Wide (front panel width)
xTCA	ACTA and /or MicroTCA standard platforms

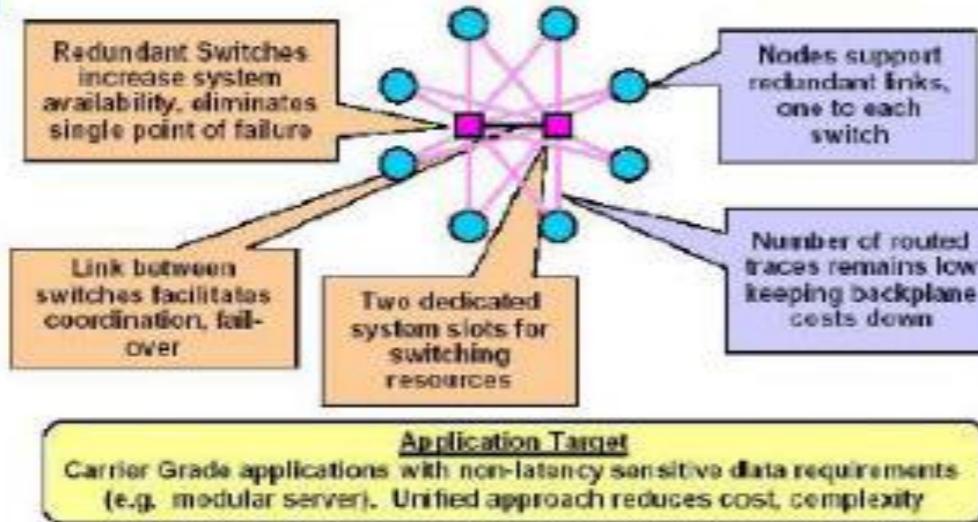
- Currently Vadatech VT892 quite common in CMS (variant with vertical airflow)



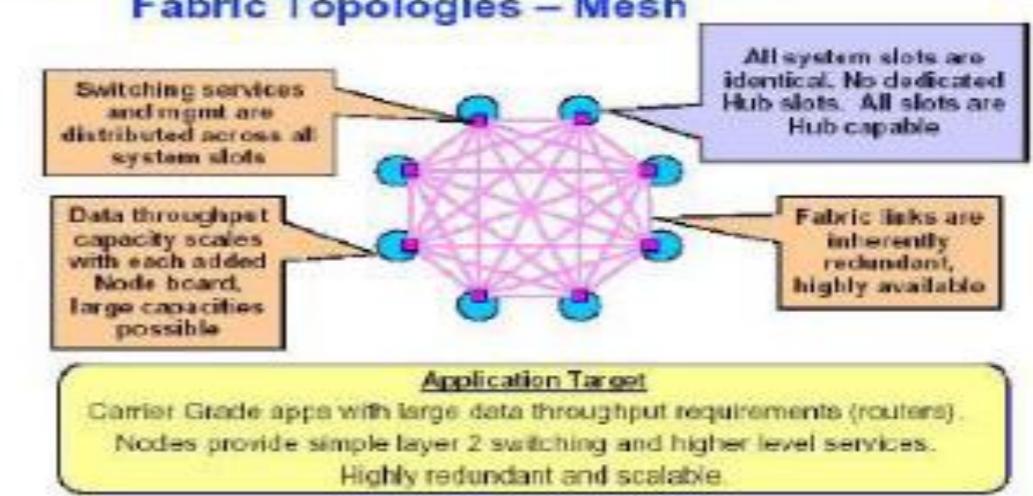
uTCA Backplane Types



Fabric Topologies – Dual Star

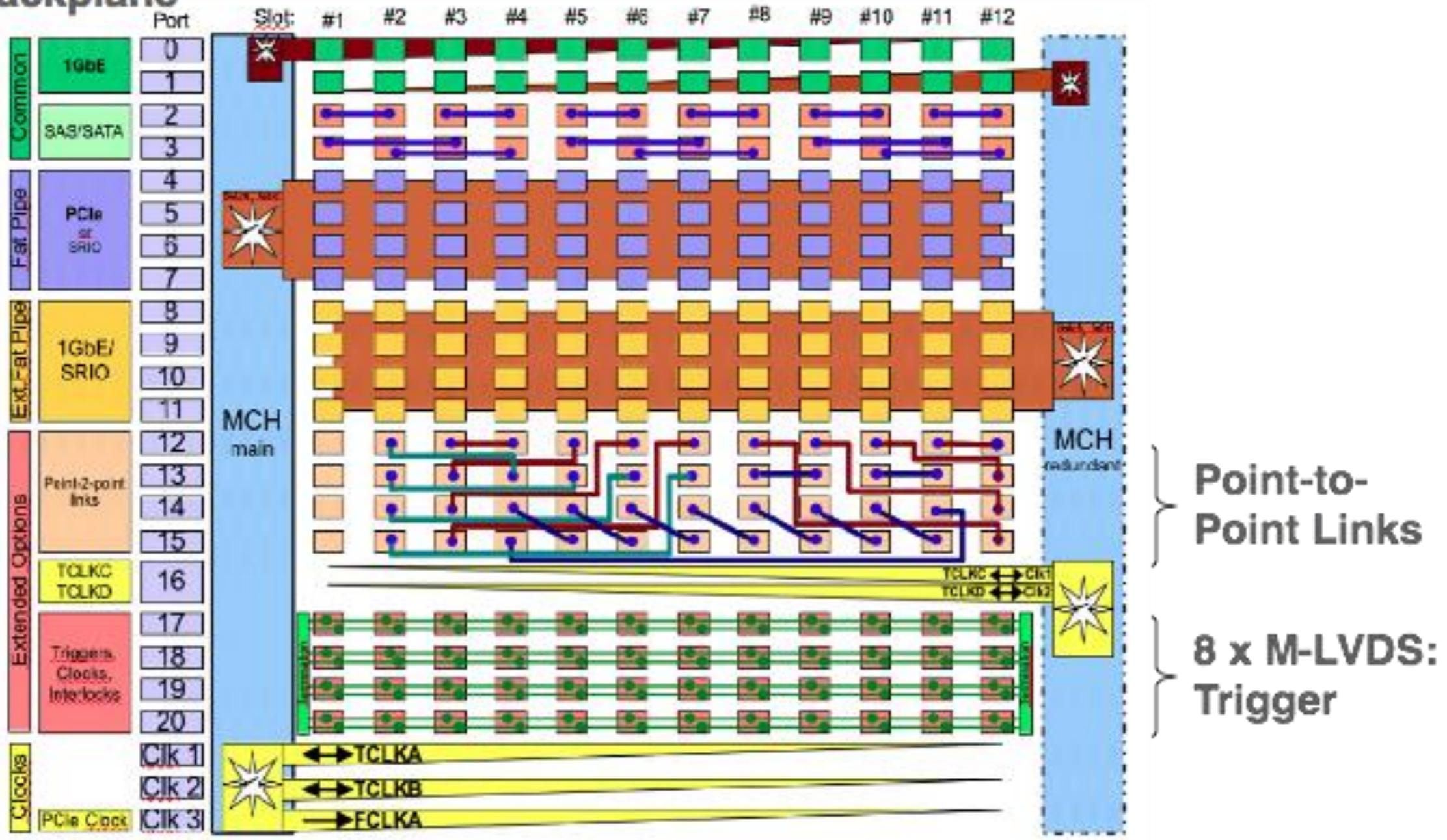


Fabric Topologies – Mesh



Double-star Backplane

12 Slot MTCA.4 Backplane





uTCA for Physics (MTCA.4)

- New variant to allow rear-transition modules (RTM)

Example 2: Generic FPGA & Fast-Slow 12 bit ADCs RTM for interlocks



Courtesy D. Brown, SLAC & TEWS Co.



June 4-5, 2012

New Developments in I&C Standards for
Physics

42



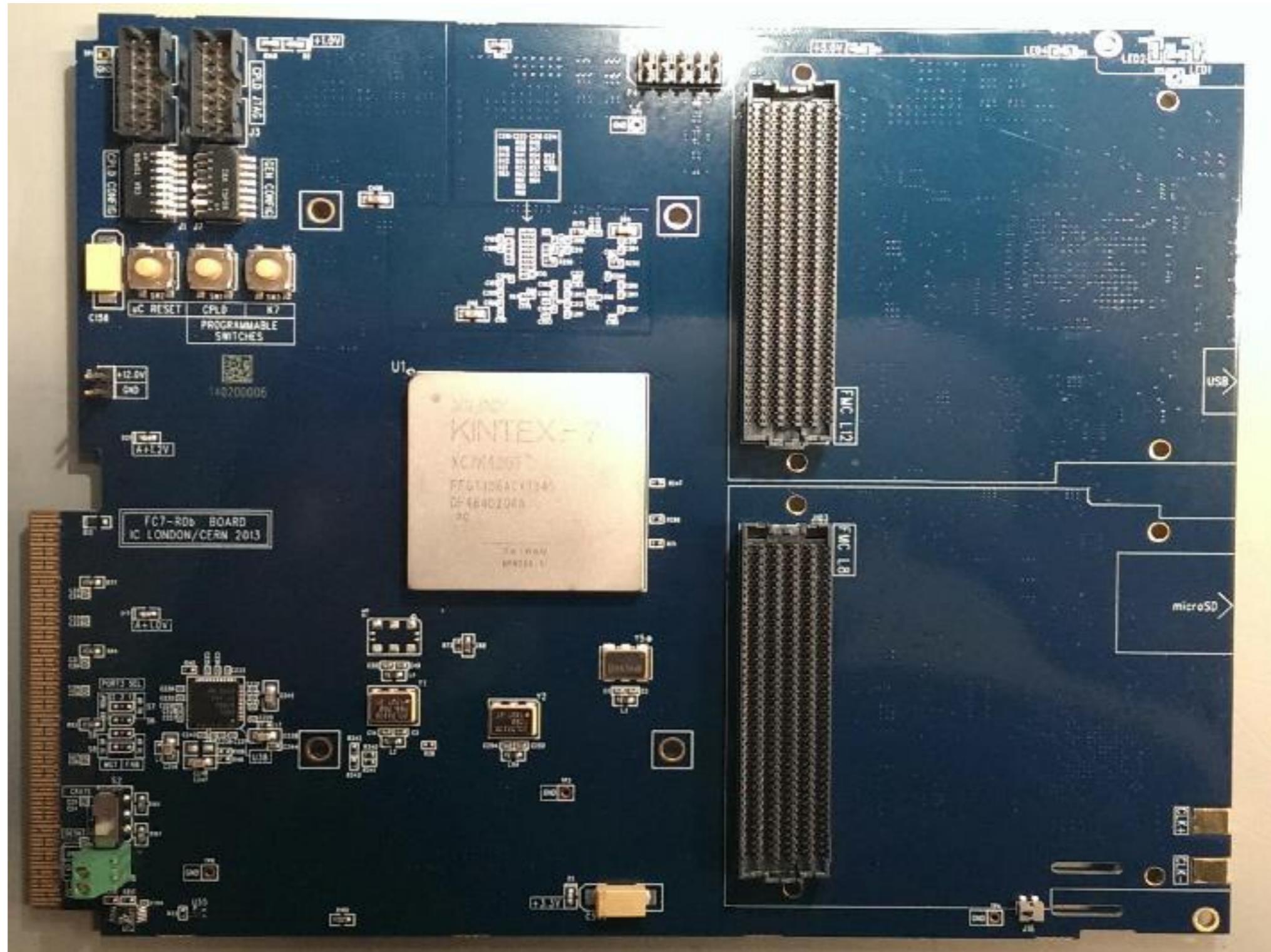


Examples of uTCA Board

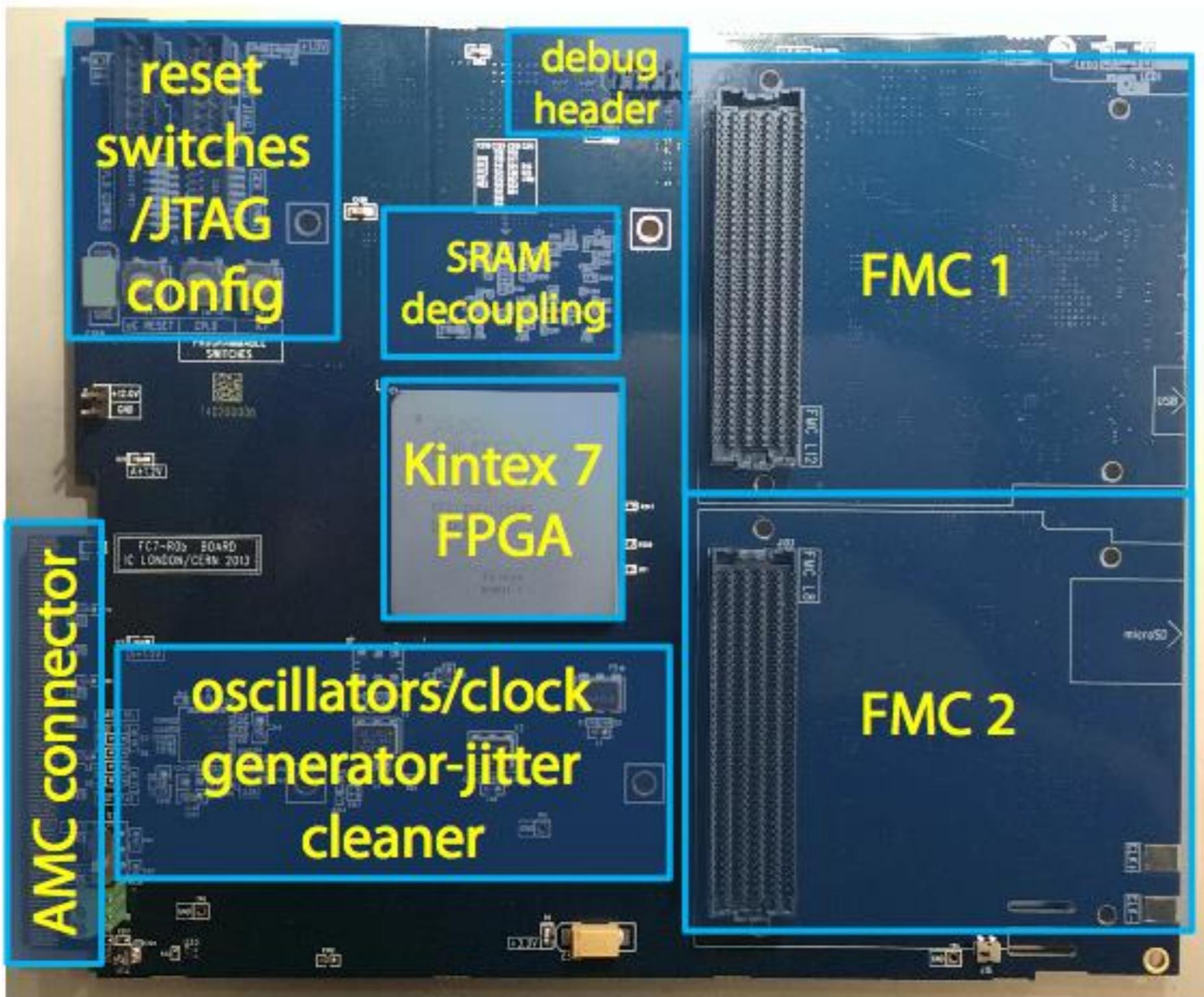
- › CMS-heavy (apologies)
 - › Could find many more examples from XFEL, FAIR, etc.
- › Module aimed at test-bench , beam-test work: GLIB
- › Module aimed at being a “Front End” board that receives data from detector (FC7)
- › Module aimed at data processing for e.g. trigger (MP7)

FC7 Prototype Front-end AMC

- ~10GHz
(MP7)
- Good performance
(weave misaligned with PCB)
- Constant low dielectric loss tangent -
EPSI-N4000
13 Nelco
- 16 layers

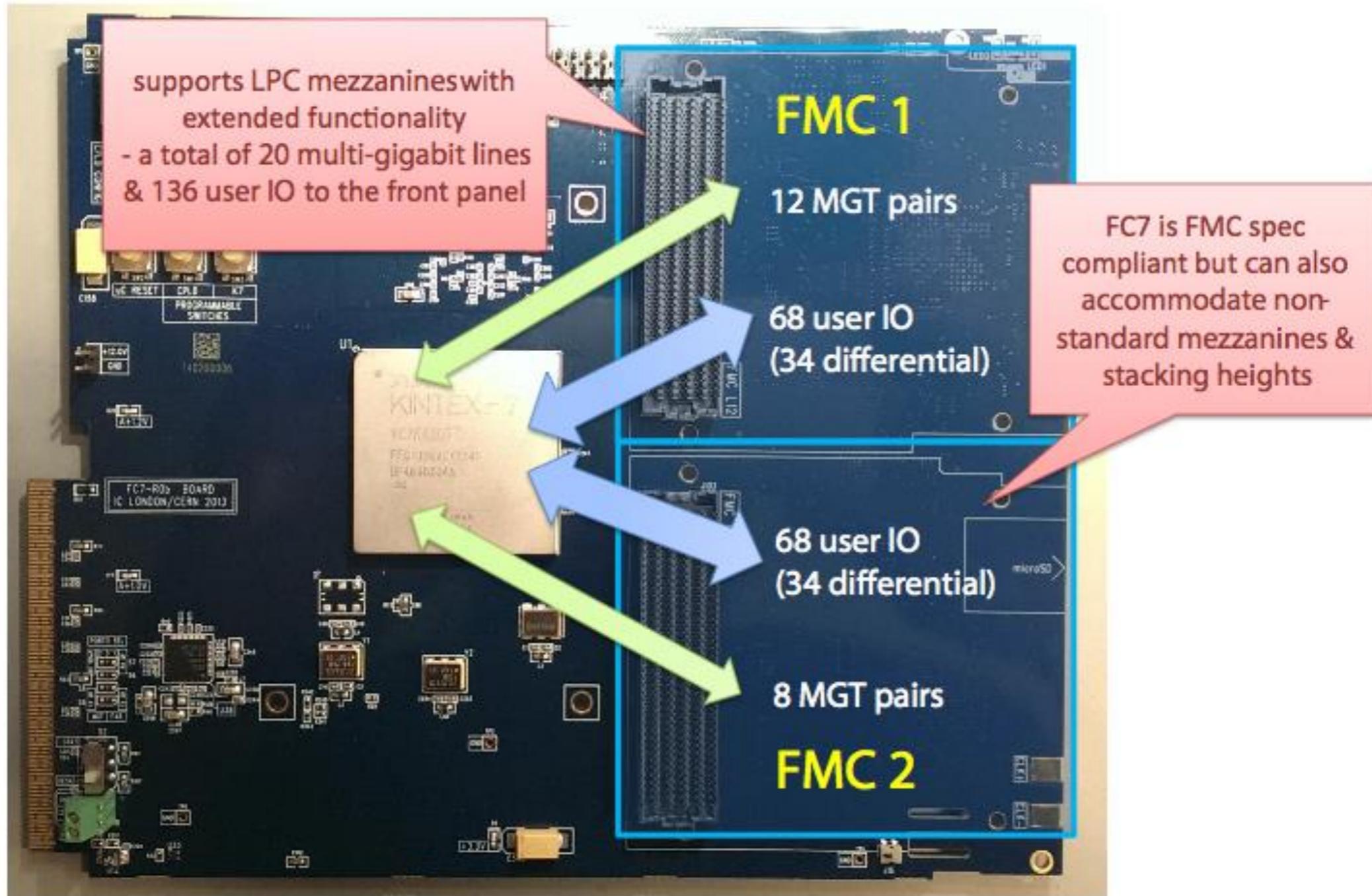


FC7 Block Diagram

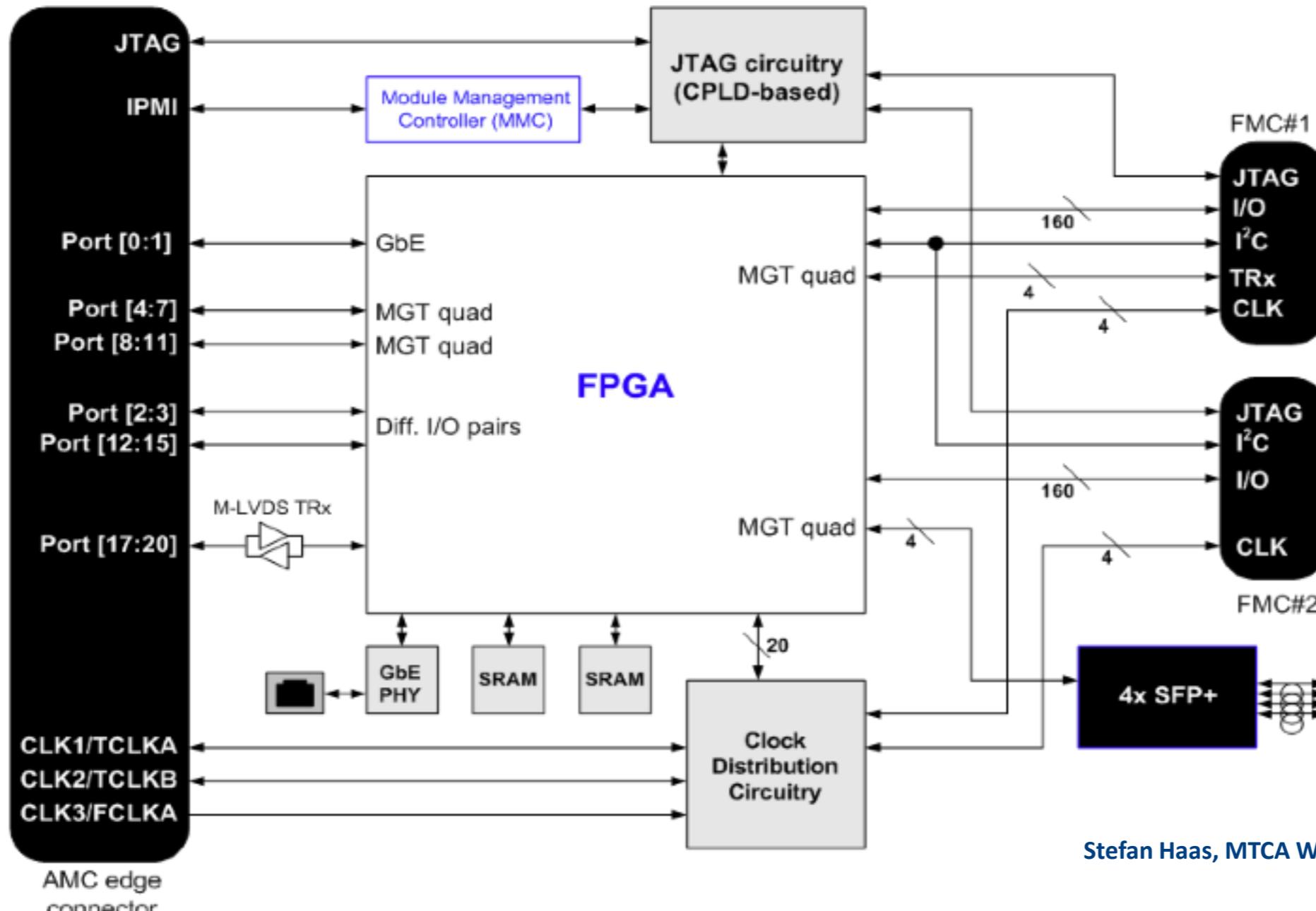


FC7 - Input from Detector

- Custom input circuitry on “FPGA Mezzanine Cards”



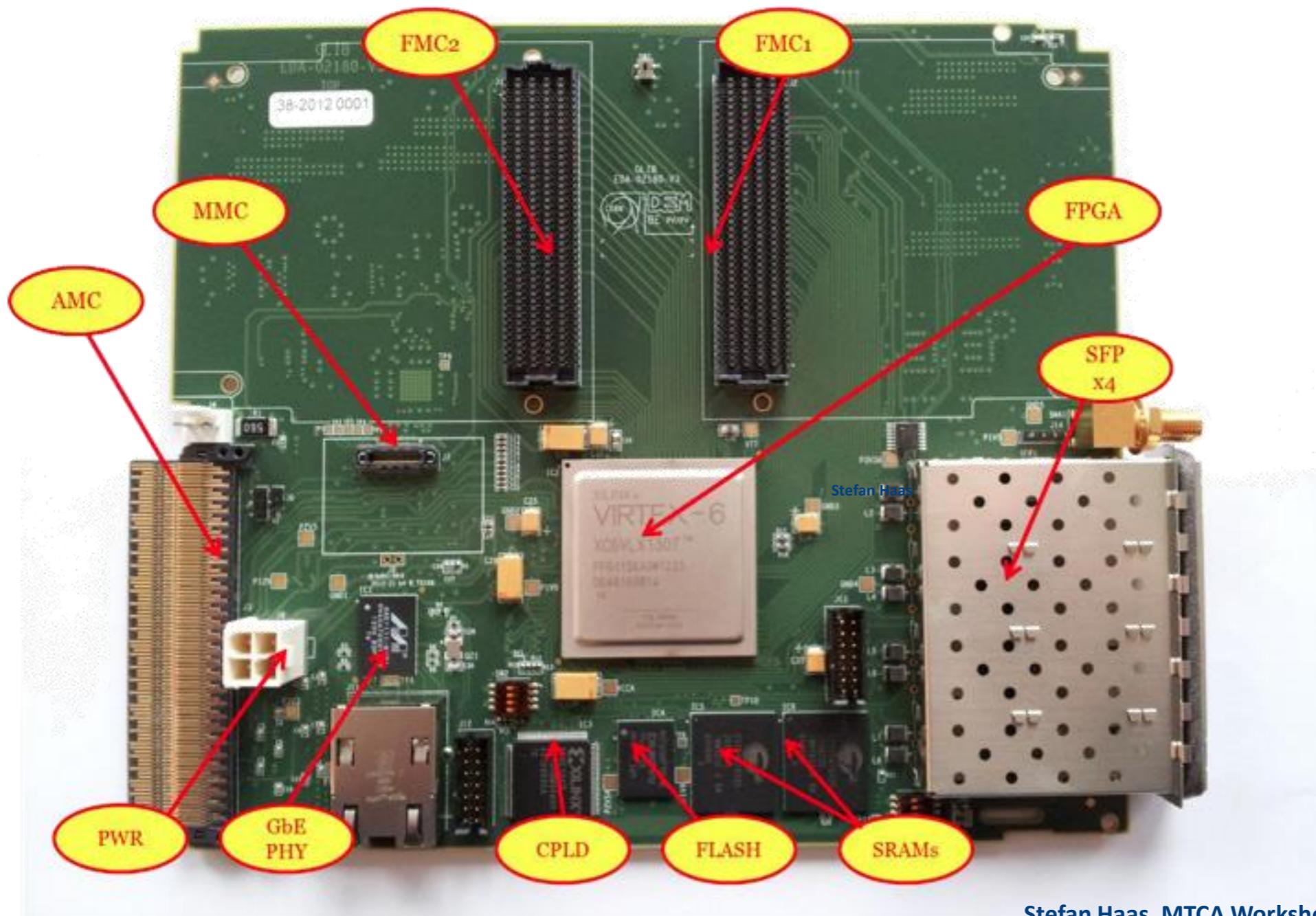
Generic uTCA Test-platform (GLIB,CERN)



Stefan Haas, MTCA Workshop, DESY, 12. Dec. 2012

- Test-bench , beam-test
- Two FMC (FPGA Mezzanine Card) site, SFP cages

Generic uTCA Test-platform (GLIB,CERN)

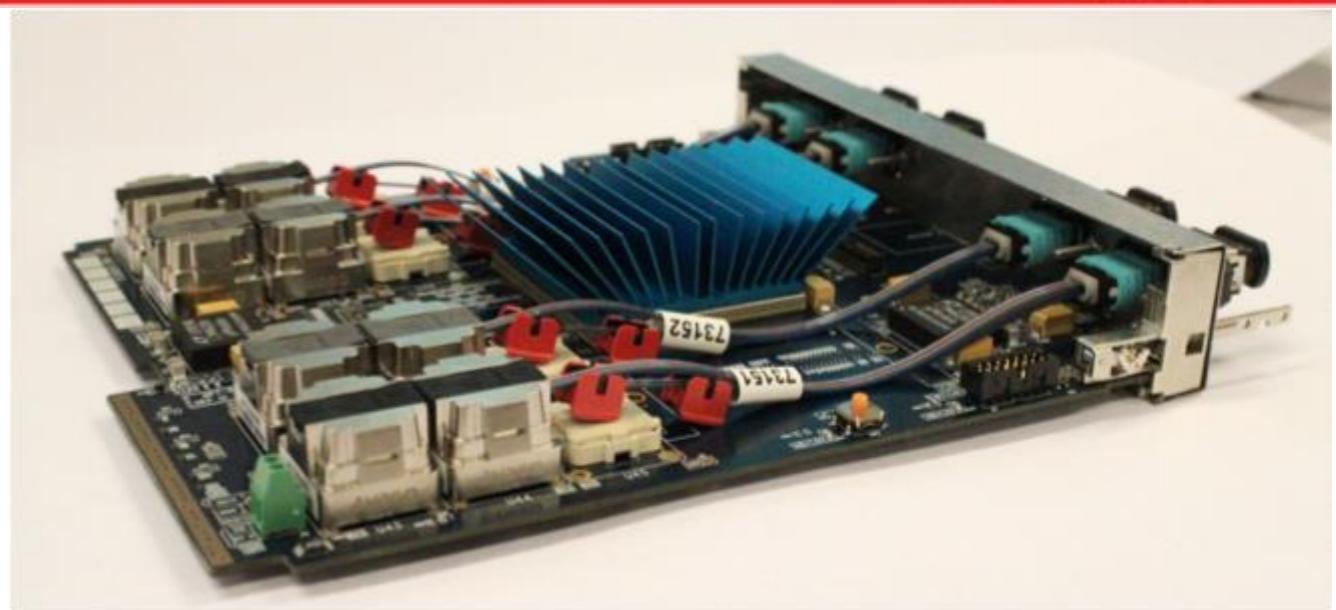


Stefan Haas, MTCA Workshop, DESY, 12. Dec. 2012

- Available from CERN
- Firmware/ software skeleton available (uses IPBus)

CMS uTCA Trigger Processor: MP7

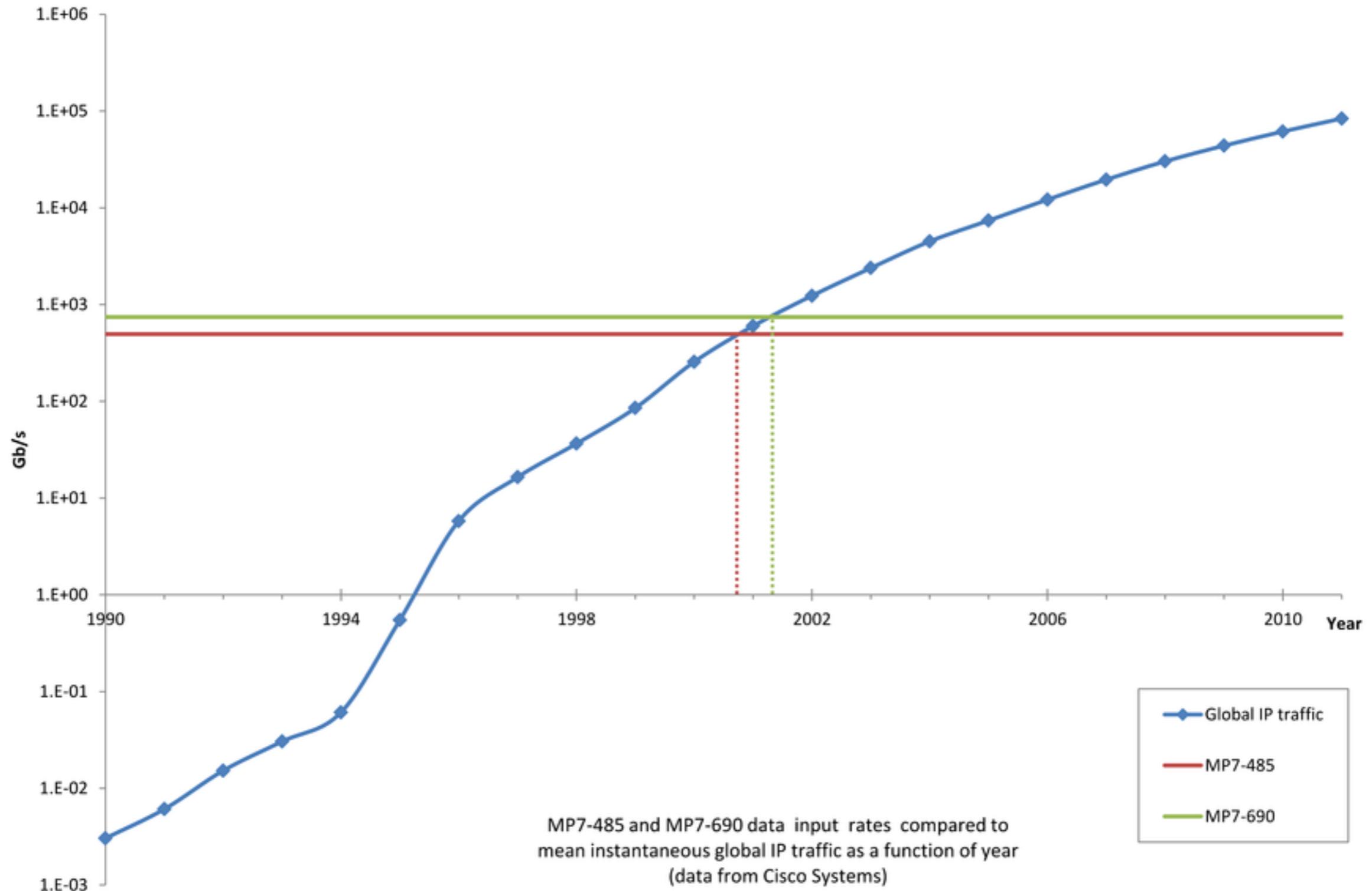
- MP7 card: building block for L1 and DAQ systems
- Large Virtex-7 series FPGA (6 Billion transistors); 144Mb fast RAM
- 1.4Tb/ s of low-latency IO on optical links; 50Gb/ s backplane IO
- Integrated into industry-standard uTCA software / hardware environment
- Will future L1 / FE look more like a commercial switch fabric?



A.
Ros
e,
Im
perial



Huge Data Throughput....





Setup and Control

- Current generation of VME crates typically use VME backplane to set-up/ configure boards.
 - Detector data moved around on custom back-plane/ rear-transition-modules
- Need to replace this functionality in an xTCA system
- One solution is IPBus
- Developed for use in CMS upgrades.
 - Now being adopted by several other experiments

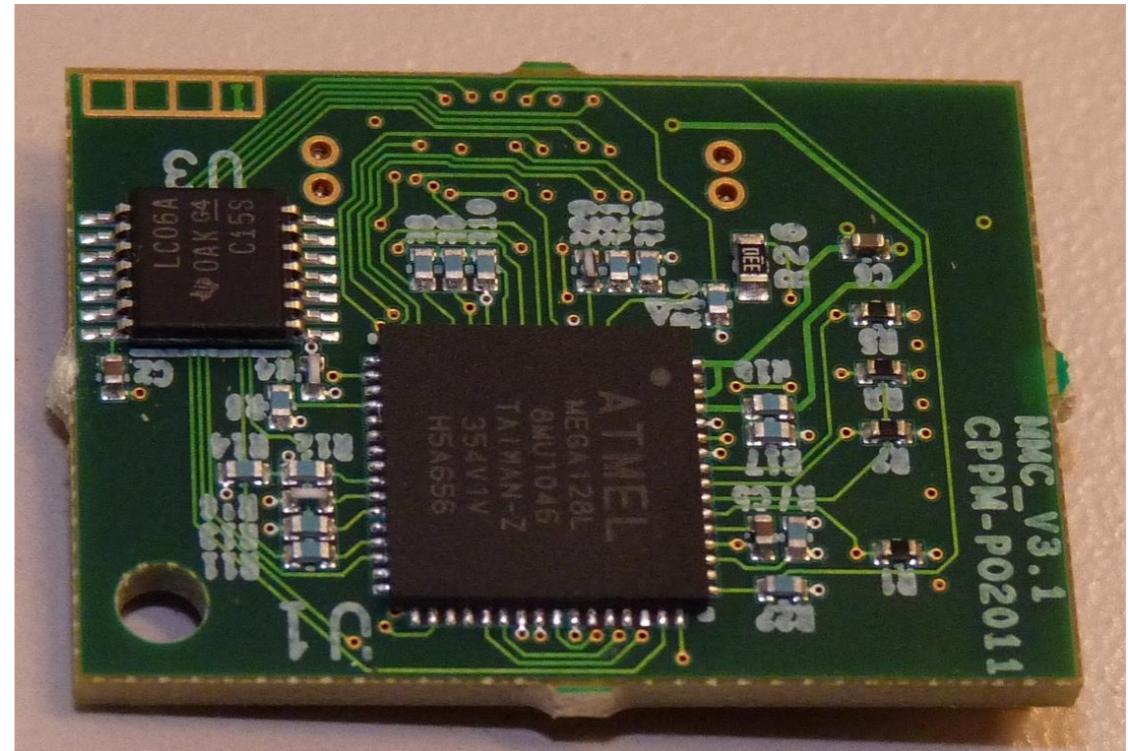


IPBus

- IPbus is a simple, IP-based control protocol
 - Originally created by Jeremy Mans, et al in 2009/ 2010
- S/ w and f/ w development is being done by a UK collaboration University of Bristol and Imperial College London, Rutherford Appleton Laboratory
- Protocol describes basic transactions needed to control h/ w
Read/ write, non-incrementing read/ write, etc, etc.
- UDP is the recommended transport implementation
 - Easiest to implement in firmware
 - Uses relatively few FPGA resources
- Interface inside FPGA looks like a A32/ D32 bus. (sub-set of Wishbone)
- See <https://svnweb.cern.ch/trac/cactus>

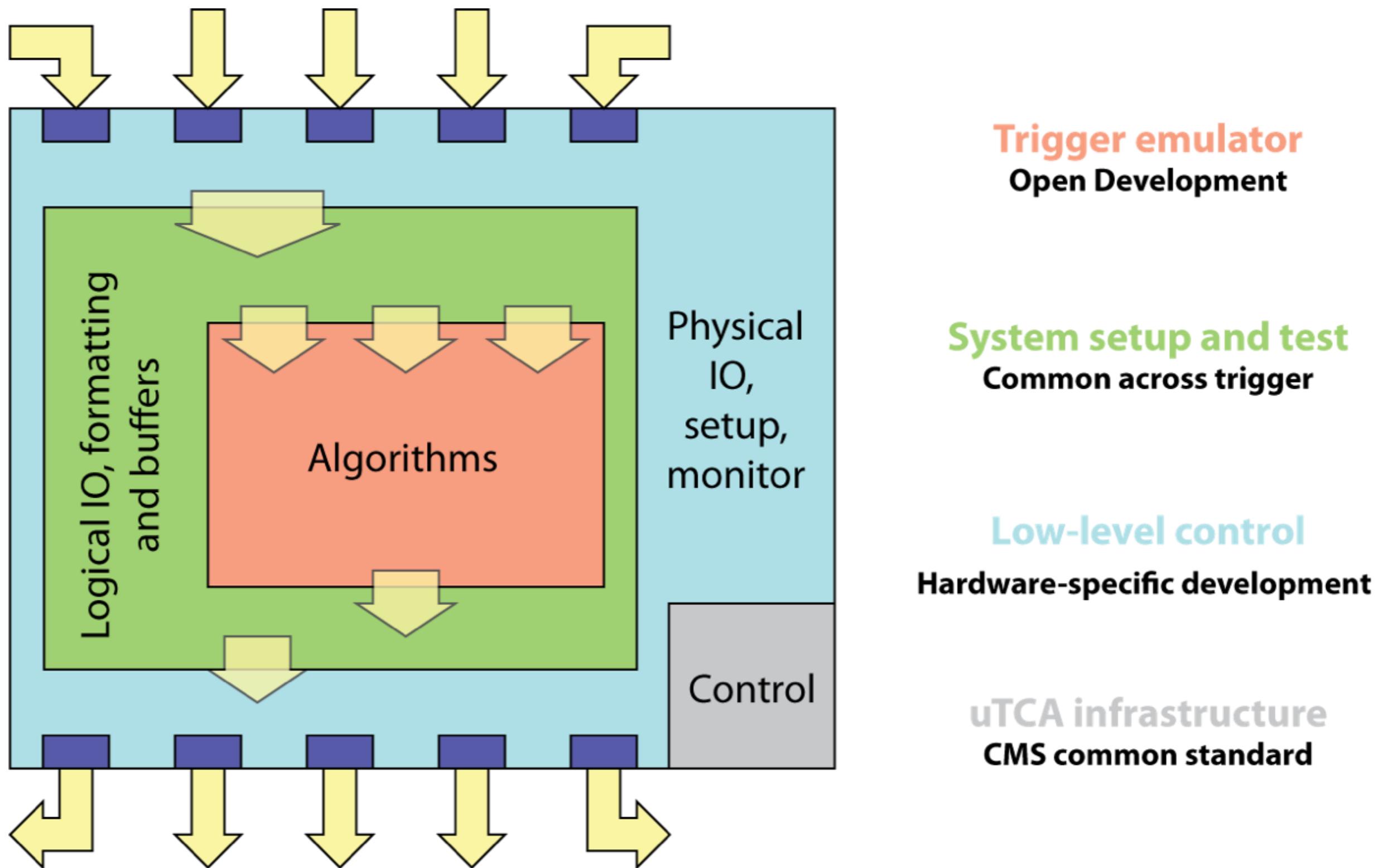
Board Start-up (MMC)

- ATCA, uTCA boards need to negotiate with power supply when inserted in crate.
 - Allows hot-swap of boards
 - means that without MMC an AMC won't do anything when inserted in crate.
- Strongly recommend: get hold of somebody else's code or hardware for MMC. See e.g. https://espace.cern.ch/ph-dep-ESE-BE-uTCAEvaluationProject/MMC_project/default.aspx





Firmware / Software Stack





Summary

- Prediction is very difficult, especially about the future
 - (ascribed to Neils Bohr)
- but it does look like the next generation of off-detector electronics for large HEP experiments will use xTCA
 - Has reached critical mass. Baseline for CMS upgrades, used for XFEL, at FAIR.
- High performance, but a rather complex system
 - Use off-the-shelf components where possible
 - e.g. MMC, setup/ control firmware